**Vishay Siliconix** 

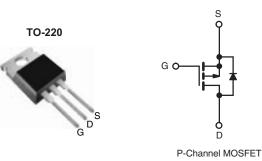
RoHS

COMPLIANT



### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 100				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	0.30			
Q <sub>g</sub> (Max.) (nC)	38				
Q <sub>gs</sub> (nC)	6.8				
Q <sub>gd</sub> (nC)	21				
Configuration	Single				



#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Lead (Pb)-free Available

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRF9530PbF
	SiHF9530-E3
SnPb	IRF9530
	SiHF9530

<b>ABSOLUTE MAXIMUM RATINGS</b> T	<sub>C</sub> = 25 °C, ur	less otherw	ise noted				
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	- 100	v		
Gate-Source Voltage			V <sub>GS</sub>	± 20	v		
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>C</sub> = 25 °C	1-	- 12			
		T <sub>C</sub> = 100 °C	ID	- 8.2	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 48			
Linear Derating Factor				0.59	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	400	mJ		
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	- 12	A		
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub> 8.8		mJ		
Maximum Power Dissipation	$T_{\rm C} = 2$	25 °C	P <sub>D</sub> 88		W		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt - 5.5		V/ns		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for <sup>-</sup>	10 s		300 <sup>d</sup>			
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in		
			Γ	1.1	N · m		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = -25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 4.2 mH,  $R_G = 25 \Omega$ ,  $I_{AS} = -12 \text{ A}$  (see fig. 12).

c.  $I_{SD} \leq$  - 12 A, dI/dt  $\leq$  140 A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq$  175 °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RAT	TINGS								
PARAMETER	SYMBOL	TYP. MAX.			UNIT				
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 - 1.7			°C/W				
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>								
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>				L				
<b>SPECIFICATIONS</b> $T_J = 25 \degree C$ ,	unless otherw	vise noted							
PABAMETER	SYMBOL	1		IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = -	250 μA	- 100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference			-	- 0.10	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	-	/ <sub>GS</sub> , I <sub>D</sub> = -		- 2.0	-	- 4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$			-	_	± 100	nA	
	-000	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -80 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150 \text{ °C}$		-	_	- 100	μΑ		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			-	-	- 500			
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V		-	-	-	0.30	Ω	
Forward Transconductance	g <sub>fs</sub>		50 V, I <sub>D</sub> =		3.7	-	-	S	
Dynamic	0.0					I			
Input Capacitance	C <sub>iss</sub>				-	860	-		
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 25 V, f = 1.0 MHz, see fig. 5		-	340	-	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	93	-			
Total Gate Charge	Q <sub>g</sub>				-	-	38	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V	$I_{\rm D} = -12$	<sub>D</sub> = - 12 A, V <sub>DS</sub> = - 80 V, see fig. 6 and 13 <sup>b</sup>	-	-	6.8		
Gate-Drain Charge	Q <sub>gd</sub>	see fi		ig. 6 and 135	-	-	21		
Turn-On Delay Time	t <sub>d(on)</sub>				-	12	-		
Rise Time	tr	$V_{DD}$ = - 50 V, I <sub>D</sub> = - 12 A, R <sub>G</sub> = 12 Ω,R <sub>D</sub> = 3.9 Ω, see fig. 10 <sup>b</sup>		-	52	-	ns		
Turn-Off Delay Time	t <sub>d(off)</sub>			-	31	-			
Fall Time	tf	-			-	39	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH		
Internal Source Inductance	Ls			-	7.5	-			
Drain-Source Body Diode Characteristic	s					1			
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 12	A		
Pulsed Diode Forward Currenta	I <sub>SM</sub>			-	-	- 48			
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 \ ^{\circ}C, I_S = -12 \ A, V_{GS} = 0 \ V^b$			-	-	- 6.3	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = -12 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	120	240	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.46	0.92	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-			-on is don	ninated by			

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.

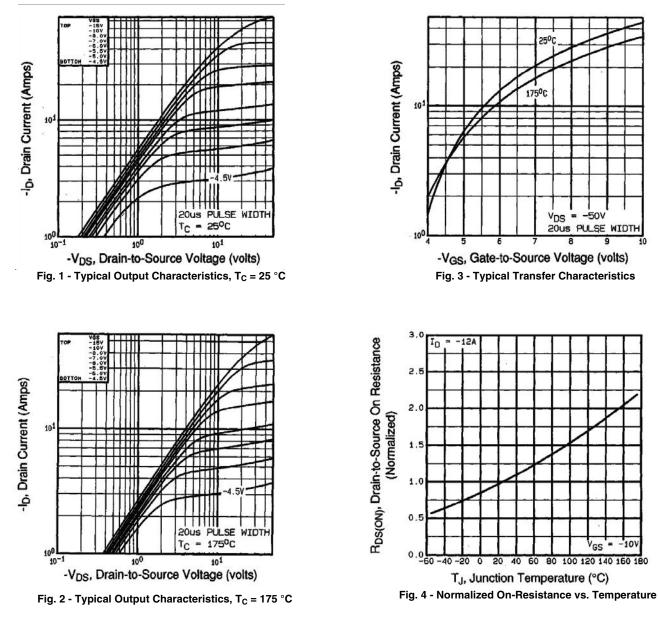


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V<sub>DS</sub> = -50V 20us PULSE WIDTH

8





10

GS

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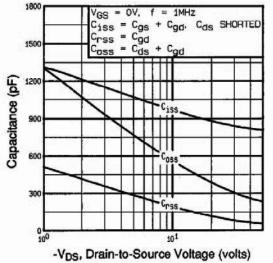


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

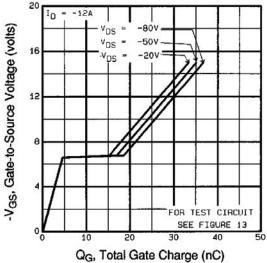
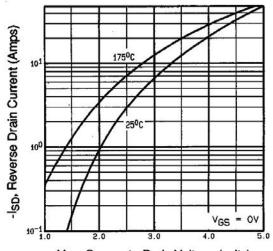
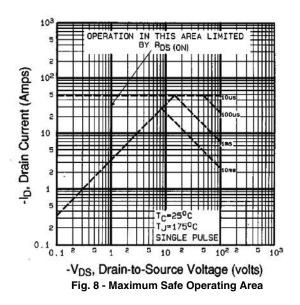


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



-V<sub>SD</sub>, Source-to-Drain Voltage (volts) Fig. 7 - Typical Source-Drain Diode Forward Voltage





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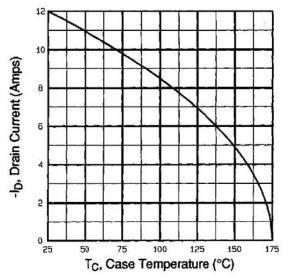


Fig. 9 - Maximum Drain Current vs. Case Temperature

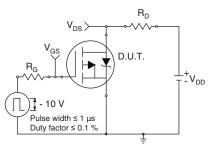


Fig. 10a - Switching Time Test Circuit

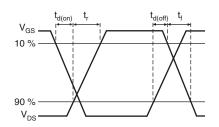


Fig. 10b - Switching Time Waveforms

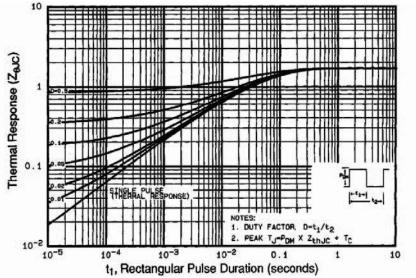


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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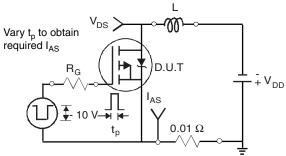
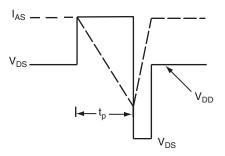
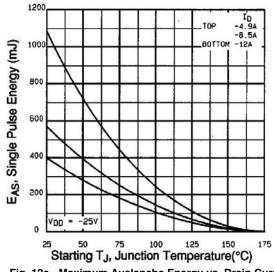


Fig. 12a - Unclamped Inductive Test Circuit



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Fig. 12b - Unclamped Inductive Waveforms





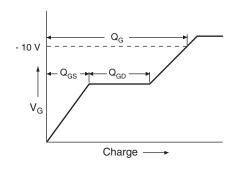
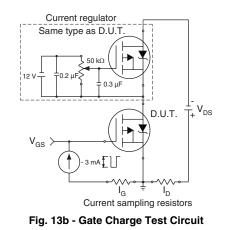
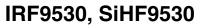


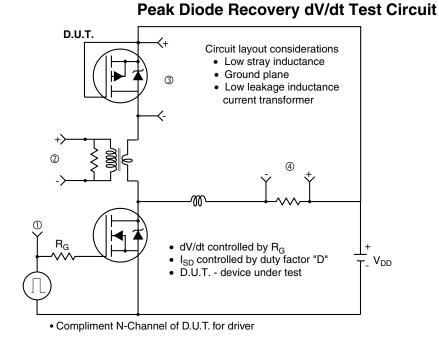
Fig. 13a - Basic Gate Charge Waveform

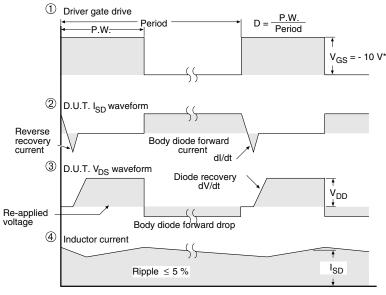


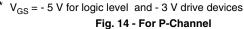


### **Vishay Siliconix**









Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91076.

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